



EtraLED-LUME-11020 Lumens Modular Passive Star LED Heat Sink Φ110mm

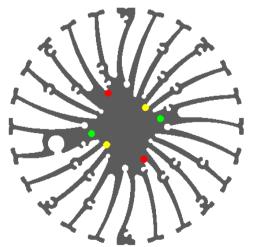
Features VS Benefits

- * The EtraLED-LUME-11020 Lumens Pin Fin LED Heat Sinks are specifically designed for luminaires using the Lumens LED engines.
- * Mechanical compatibility with direct mounting of the LED engines to the LED cooler and thermal performance matching the lumen packages.
- * For spotlight and downlight designs from 1600 to 4,200 lumen.
- * Thermal resistance range Rth 1.79°C/W.
- * Modular design with mounting holes foreseen for direct mounting of Lumens Ergon COB series, and AC-ALL series LED engines.
- * Diameter 110.0mm standard height 20.0mm Other heights on request.
- * Forged from highly conductive aluminum.

Zhaga LED engine and radiator assembly is a unified future international standardization

- * Below you find an overview of Lumens COB's and LED modules which standard fit on the srar LED heat sinks.
- * In this way mechanical after work and related costs can be avoided, and lighting designers can standardize their designs on a limited number of srar LED heat sinks.





Lumens LED Modules directly Mounting Options Lumens Ergon COB_HO, COB_HO+, COB_HE Series:

ERC1812xxxxHO; ERC1812xxxxHE; ERC1820xxxxHE;

With the Zhaga Book 3 holders for the red indicator marks (Ideal Holder: 50-2101CR):

(R IR holder: 47 319 2131 50)

Without the holders for the green indicator marks.

Direct mounting with machine screws M3x6.5mm

Lumens Ergon COB_HO, COB_HO+, COB_HE Series :

ERC1507xxxxHO; ERC1507xxxxHO+ ERC1512xxxxHO; ERC1512xxxxHO+

ERC1507xxxxHE;

With the Zhaga Book 11 holders for the green indicator marks.

IDEAL Holder:50-2001CR;

3JB Holder:47.319.6104.50;

Direct mounting with machine screws M3x6.5mm

Lumens AC-ALL Series :

With the Zhaga Book 3 holders for the red indicator marks. Direct mounting with machine screws M3x6.5mm.

Please refer to the www.lumensleds.com data provided on the manual.

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Mounting Options and Drawings & Dimensions

Example: EtraLED-LUME-11020-B-1,2

Example:EtraLED-LUME-110 1 - 2 -

ample:EtraLED-LUME-110

1 Height (mm)

Anodising Color

B-Black

C-Clear

Z-Custom

Mounting Options - see graphics for details Combinations available

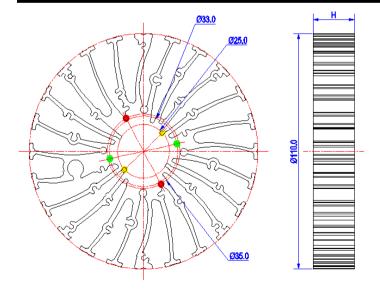
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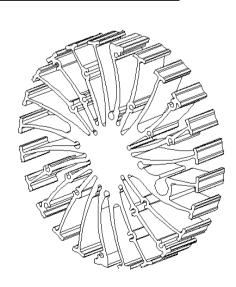
means option 1 and 2 combined

Notes:

- Mentioned models are an extraction of full product range.
- For specific mechanical adaptations please contact MingfaTech.
- MingfaTech reserves the right to change products or specifications without prior notice.

MOUNTING OPTION	Module type	Holder NO.	THREAD	THREAD DEPTH	THREAD HOLE DISTANCE
1	Ergon COB (15.85×15.85)	1	М3	6.5mm	22.0mm/ 2-@180°
	Ergon COB (17.85×17.85)	1		6.5mm	25.0mm/ 2-@180° (Zhaga book 11)
2	Ergon COB (15.85×15.85)	BJB Holder 47.319.6104.50	МЗ		
		ldeal Holder 50-2001CR			
	AC-ALL Series	Lumens		6.5mm	35.0mm/ 2-@180° (Zhaga book 3)
3	Ergon COB (17.85×17.85)	BJB Holder 47.319.2131.50	М3		
		ldeal Holder 50-2101CR			



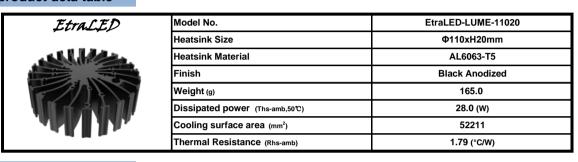








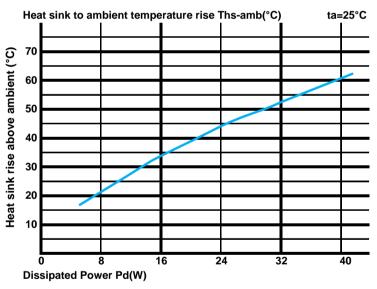
The product deta table



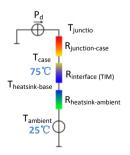
The thermal data table

- * Please be aware the dissipated power Pd is not the same as the electrical power Pe of a LED module.
- *To calculate the dissipated power please use the following formula: $Pd = Pe \times (I \eta L)$.
 - Pd Dissipated power ; Pe Electrical power ; $\eta L =$ Light effciency of the LED module;

Pd = Pe x (1-ηL)			Heat sink to ambient thermal resistance Rhs-amb (°C/W)	Heat sink to ambient temperature rise Ths-amb (°C)				
	(1-1 L)		EtraLED-LUME-11020					
W)	8.0	2.50	20.0					
	er Pd(16.0	2.06	33.0				
Dissipated Power Pd(W)	24.0	1.83	44.0					
	32.0	1.63	52.0					
	40.0	1.50	60.0					



- *The aluminum substrate side of the package outer shell is thermally connected to the heat sink via TIM (Thermal interface material).
- $\label{thm:mingFar} \mbox{MingFa recommends the use of a high thermal conductive interface between the LED module and the LED cooler.}$
- $Either thermal\ grease, A\ thermal\ pad\ or\ a\ phase\ change\ thermal\ pad\ thickness\ 0.1-0.15 mm\ is\ recommended.$



- *Thermal resistance is a heat property and a measurement of a temperature difference by which an object or material resists a heat flow. Geometric shapes are different, the thermal resistance is different. Formula: $\theta = (Ths Ta)/Pd$
- θ Thermal Resistance [°C/M]; Ths Heatsink temperature; Ta Ambient temperature;
- *The thermal resistance between the junction section of the light-emitting diode and the aluminum substrate side of the package outer shell is $R_{junction-case}$, the thermal resistance of the TIM outside the package is $R_{interface}(TIM)$ ["C,M"], the thermal resistance with the heat sink is $R_{heatsink-ambient}$ ["C,M"], and the ambient temperature is $T_{ambient}$ ["C].
- *Thermal resistances outside the package $R_{interface \, (TIM)}$ and $R_{heatsink-ambient}$ can be integrated into the thermal resistance $R_{case-ambient}$ at this point. Thus, the following formula is also used: $T_{junction} = (R_{junction-case} + R_{case-ambient}) \cdot Pd + T_{ambient}$

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